

FEATURES

High speed

140 MHz bandwidth (3 dB, $G = +1$)

120 MHz bandwidth (3 dB, $G = +2$)

35 MHz bandwidth (0.1 dB, $G = +2$)

2500 V/ μ s slew rate

25 ns settling time to 0.1% (for a 2 V step)

65 ns settling time to 0.01% (for a 10 V step)

Excellent video performance ($R_L = 150 \Omega$)

0.01% differential gain, 0.01° differential phase

Voltage noise of 1.9 nV/ $\sqrt{\text{Hz}}$

Low distortion: THD = -74 dB at 10 MHz

Excellent dc precision: 3 mV max input offset voltage

Flexible operation

Specified for ± 5 V and ± 15 V operation

± 2.3 V output swing into a 75 Ω load ($V_S = \pm 5$ V)

APPLICATIONS

Video crosspoint switchers, multimedia broadcast systems

HDTV compatible systems

Video line drivers, distribution amplifiers

ADC/DAC buffers

DC restoration circuits

Medical

Ultrasound

PET

Gamma

Counter applications

MIL-STD-883B parts available

GENERAL DESCRIPTION

A wideband current feedback operational amplifier, the AD811 is optimized for broadcast-quality video systems. The -3 dB bandwidth of 120 MHz at a gain of +2 and the differential gain and phase of 0.01% and 0.01° ($R_L = 150 \Omega$) make the AD811 an excellent choice for all video systems. The AD811 is designed to meet a stringent 0.1 dB gain flatness specification to a bandwidth of 35 MHz ($G = +2$) in addition to low differential gain and phase errors. This performance is achieved whether driving one or two back-terminated 75 Ω cables, with a low power supply current of 16.5 mA. Furthermore, the AD811 is specified over a power supply range of ± 4.5 V to ± 18 V.

CONNECTION DIAGRAMS

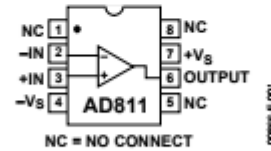
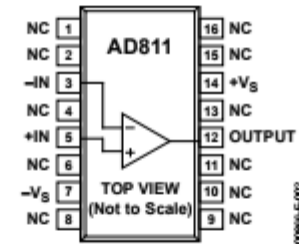


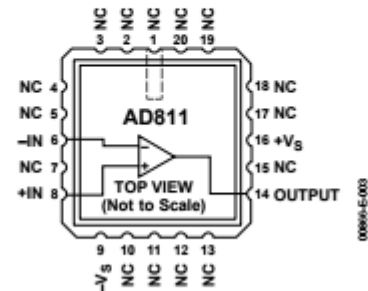
Figure 1. 8-Lead Plastic (N-8), CERDIP (Q-8), SOIC_N (R-8)



NOTES

1. NC = NO CONNECT. DO NOT CONNECT TO THIS PIN.

Figure 2. 16-Lead SOIC_W (RW-16)



NOTES

1. NC = NO CONNECT. DO NOT CONNECT TO THIS PIN.

Figure 3. 20-Terminal LCC (E-20-1)

The AD811 is also excellent for pulsed applications where transient response is critical. It can achieve a maximum slew rate of greater than 2500 V/ μ s with a settling time of less than 25 ns to 0.1% on a 2 V step and 65 ns to 0.01% on a 10 V step.

The AD811 is ideal as an ADC or DAC buffer in data acquisition systems due to its low distortion up to 10 MHz and its wide unity gain bandwidth. Because the AD811 is a current feedback amplifier, this bandwidth can be maintained over a wide range of gains. The AD811 also offers low voltage and current noise of 1.9 nV/ $\sqrt{\text{Hz}}$ and 20 pA/ $\sqrt{\text{Hz}}$, respectively, and excellent dc accuracy for wide dynamic range applications.

SPECIFICATIONS

At $T_A = +25^\circ\text{C}$, $V_S = \pm 15\text{ V dc}$, $R_{\text{LOAD}} = 150\ \Omega$, unless otherwise noted.

Table 1.

Parameter	Conditions	V_S	AD811J/AD811A ¹			AD811S ²			Unit
			Min	Typ	Max	Min	Typ	Max	
DYNAMIC PERFORMANCE									
Small Signal Bandwidth (No Peaking)									
-3 dB									
G = +1	$R_{\text{FB}} = 562\ \Omega$	$\pm 15\text{ V}$		140			140		MHz
G = +2	$R_{\text{FB}} = 649\ \Omega$	$\pm 15\text{ V}$		120			120		MHz
G = +2	$R_{\text{FB}} = 562\ \Omega$	$\pm 15\text{ V}$		80			80		MHz
G = +10	$R_{\text{FB}} = 511\ \Omega$	$\pm 15\text{ V}$		100			100		MHz
0.1 dB Flat									
G = +2	$R_{\text{FB}} = 562\ \Omega$	± 15		25			25		MHz
	$R_{\text{FB}} = 649\ \Omega$	± 15		35			35		MHz
Full Power Bandwidth ³	$V_{\text{OUT}} = 20\text{ V p-p}$	± 15		40			40		MHz
Slew Rate	$V_{\text{OUT}} = 4\text{ V p-p}$	± 15		400			400		V/ μs
	$V_{\text{OUT}} = 20\text{ V p-p}$	± 15		2500			2500		V/ μs
Settling Time to 0.1%	10 V Step, $A_V = -1$	± 15		50			50		ns
Settling Time to 0.01%	10 V Step, $A_V = -1$	± 15		65			65		ns
Settling Time to 0.1%	2 V Step, $A_V = -1$	± 15		25			25		ns
Rise Time, Fall Time	$R_{\text{FB}} = 649$, $A_V = +2$	± 15		3.5			3.5		ns
Differential Gain	$f = 3.58\text{ MHz}$	± 15		0.01			0.01		%
Differential Phase	$f = 3.58\text{ MHz}$	± 15		0.01			0.01		Degree
THD at $f_c = 10\text{ MHz}$	$V_{\text{OUT}} = 2\text{ V p-p}$, $A_V = +2$	± 15		-74			-74		dBc
Third-Order Intercept ⁴	At $f_c = 10\text{ MHz}$	± 15		36			36		dBm
		± 15		43			43		dBm
INPUT OFFSET VOLTAGE									
Offset Voltage Drift	T_{MIN} to T_{MAX}	$\pm 5\text{ V}$, $\pm 15\text{ V}$		0.5	3		0.5	3	mV
					5			5	mV
				5			5		$\mu\text{V}/^\circ\text{C}$
INPUT BIAS CURRENT									
-Input	T_{MIN} to T_{MAX}	$\pm 5\text{ V}$, $\pm 15\text{ V}$		2	5		2	5	μA
					15			30	μA
+Input	T_{MIN} to T_{MAX}	$\pm 5\text{ V}$, $\pm 15\text{ V}$		2	10		2	10	μA
					20			25	μA
TRANSRESISTANCE									
	T_{MIN} to T_{MAX}								
	$V_{\text{OUT}} = \pm 10\text{ V}$								
	$R_L = \infty$	$\pm 15\text{ V}$	0.75	1.5			0.75	1.5	M Ω
	$R_L = 200\ \Omega$	$\pm 15\text{ V}$	0.5	0.75			0.5	0.75	M Ω
	$V_{\text{OUT}} = \pm 2.5\text{ V}$								
	$R_L = 150\ \Omega$	$\pm 5\text{ V}$	0.25	0.4			0.125	0.4	M Ω
COMMON-MODE REJECTION									
V_{OS} (vs. Common Mode)									
T_{MIN} to T_{MAX}	$V_{\text{CM}} = \pm 2.5\text{ V}$	$\pm 5\text{ V}$	56	60			50	60	dB
T_{MIN} to T_{MAX}	$V_{\text{CM}} = \pm 10\text{ V}$	$\pm 15\text{ V}$	60	66			56	66	dB
Input Current (vs. Common Mode)	T_{MIN} to T_{MAX}			1	3			1	3
									$\mu\text{A/V}$
POWER SUPPLY REJECTION									
V_{OS}	$V_S = \pm 4.5\text{ V}$ to $\pm 18\text{ V}$								
T_{MIN} to T_{MAX}			60	70			60	70	dB
+Input Current	T_{MIN} to T_{MAX}			0.3	2			0.3	2
									$\mu\text{A/V}$
-Input Current	T_{MIN} to T_{MAX}			0.4	2			0.4	2
									$\mu\text{A/V}$

Parameter	Conditions	V _s	AD811J/AD811A ¹			AD811S ²			Unit
			Min	Typ	Max	Min	Typ	Max	
INPUT VOLTAGE NOISE	f = 1 kHz		1.9			1.9			nV/√Hz
INPUT CURRENT NOISE	f = 1 kHz		20			20			pA/√Hz
OUTPUT CHARACTERISTICS									
Voltage Swing, Useful Operating Range ⁵		±5 V	±2.9			±2.9			V
		±15 V	±12			±12			V
Output Current	T _J = 25°C		100			100			mA
Short-Circuit Current			150			150			mA
Output Resistance	(Open Loop at 5 MHz)		9			9			Ω
INPUT CHARACTERISTIC									
+Input Resistance			1.5			1.5			MΩ
−Input Resistance			14			14			Ω
Input Capacitance	+Input		7.5			7.5			pF
Common-Mode Voltage Range		±5 V	±3			±3			V
		±15 V	±13			±13			V
POWER SUPPLY									
Operating Range			±4.5		±18	±4.5		±18	V
Quiescent Current		±5 V	14.5		16.0	14.5		16.0	mA
		±15 V	16.5		18.0	16.5		18.0	mA
TRANSISTOR COUNT	Number of Transistors		40			40			

¹ The AD811JR is specified with ±5 V power supplies only, with operation up to ±12 V.

² See the Analog Devices military data sheet for 883B tested specifications.

³ FPBW = slew rate/(2π V_{PEAK}).

⁴ Output power level, tested at a closed-loop gain of two.

⁵ Useful operating range is defined as the output voltage at which linearity begins to degrade.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage	±18 V
AD811JR Grade Only	±12 V
Internal Power Dissipation	Observe Derating Curves
8-Lead PDIP Package	θ _{JA} = 90°C/W
8-Lead CERDIP Package	θ _{JA} = 110°C/W
8-Lead SOIC_N Package	θ _{JA} = 155°C/W
16-Lead SOIC_W Package	θ _{JA} = 85°C/W
20-Lead LCC Package	θ _{JA} = 70°C/W
Output Short-Circuit Duration	Observe Derating Curves
Common-Mode Input Voltage	±V _s
Differential Input Voltage	±6 V
Storage Temperature Range (Q, E)	−65°C to +150°C
Storage Temperature Range (N, R)	−65°C to +125°C
Operating Temperature Range	
AD811J	0°C to +70°C
AD811A	−40°C to +85°C
AD811S	−55°C to +125°C
Lead Temperature Range (Soldering 60 sec)	300°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD811 is limited by the associated rise in junction temperature. For the plastic packages, the maximum safe junction temperature is 145°C. For the CERDIP and LCC packages, the maximum junction temperature is 175°C. If these maximums are exceeded momentarily, proper circuit operation is restored as soon as the die temperature is reduced. Leaving the device in the overheated condition for an extended period can result in device burnout. To ensure proper operation, it is important to observe the derating curves in Figure 21 and Figure 24.

While the AD811 is internally short-circuit protected, this may not be sufficient to guarantee that the maximum junction temperature is not exceeded under all conditions. An important example is when the amplifier is driving a reverse-terminated 75 Ω cable and the cable's far end is shorted to a power supply. With power supplies of ±12 V (or less) at an ambient temperature of +25°C or less, and the cable shorted to a supply rail, the amplifier is not destroyed, even if this condition persists for an extended period.

METALIZATION PHOTOGRAPH

Contact the factory for the latest dimensions.

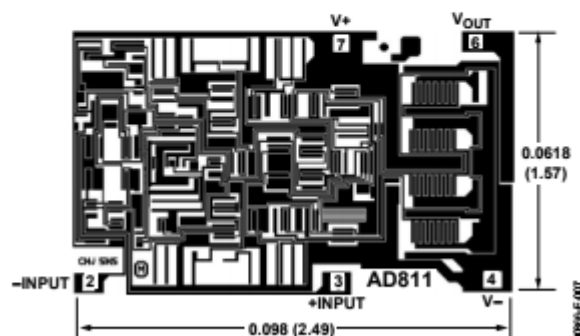


Figure 4. Metalization Photograph
Dimensions Shown in Inches and (Millimeters)

TYPICAL PERFORMANCE CHARACTERISTICS

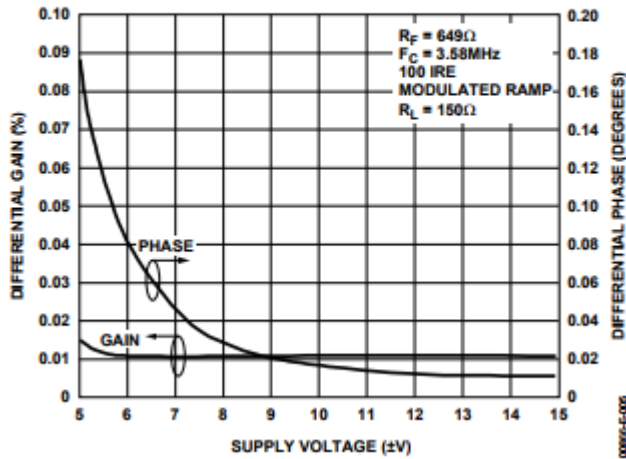


Figure 5. Differential Gain and Phase

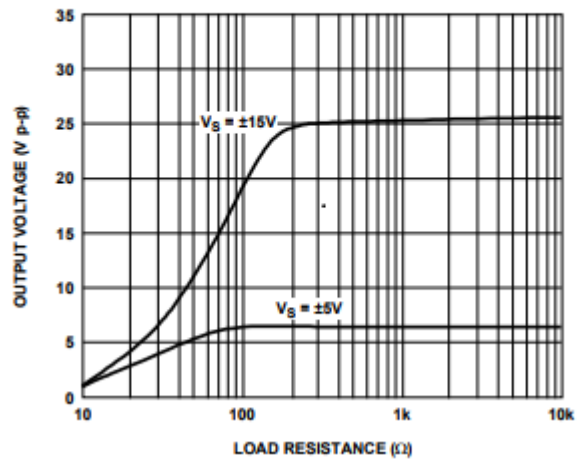


Figure 8. Output Voltage Swing vs. Resistive Load

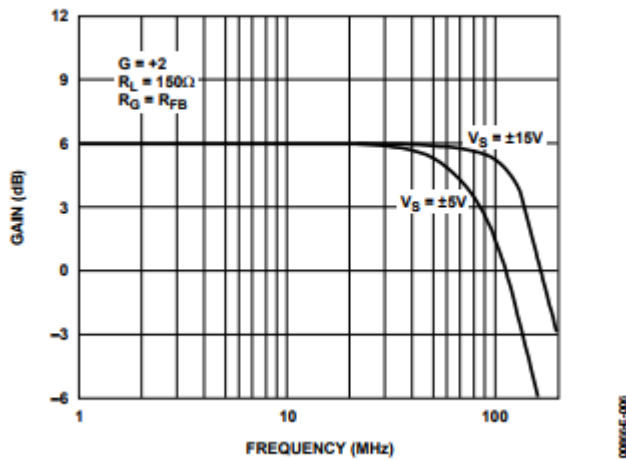


Figure 6. Frequency Response

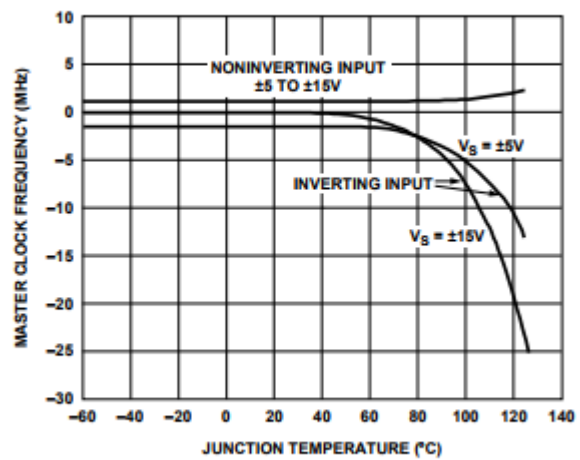


Figure 9. Input Bias Current vs. Junction Temperature

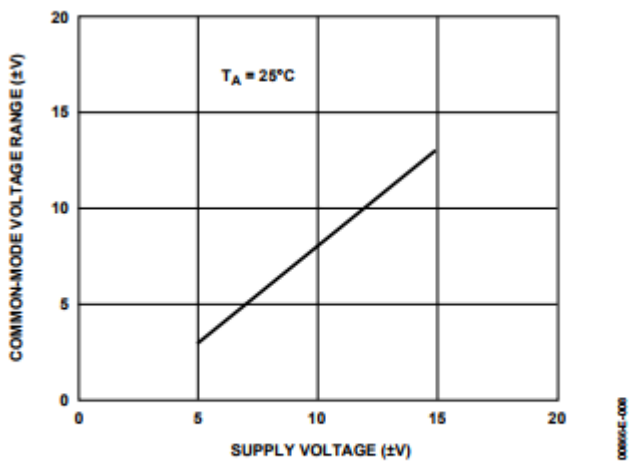


Figure 7. Input Common-Mode Voltage Range vs. Supply Voltage

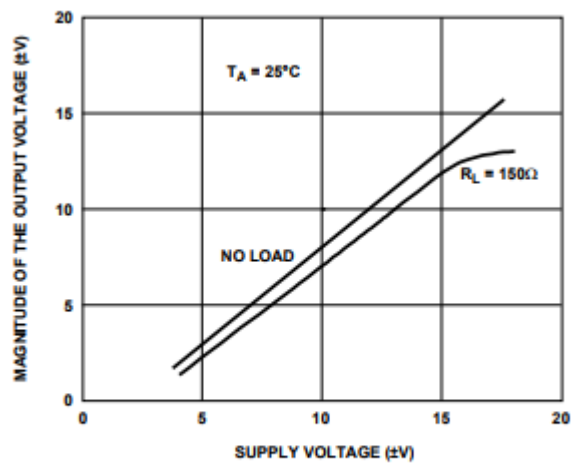


Figure 10. Output Voltage Swing vs. Supply Voltage

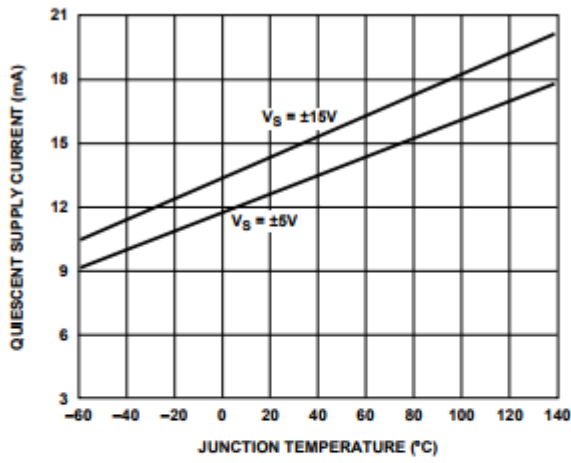


Figure 11. Quiescent Supply Current vs. Junction Temperature

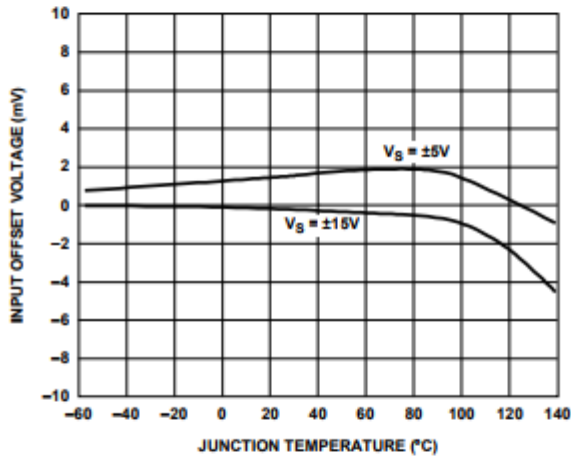


Figure 12. Input Offset Voltage vs. Junction Temperature

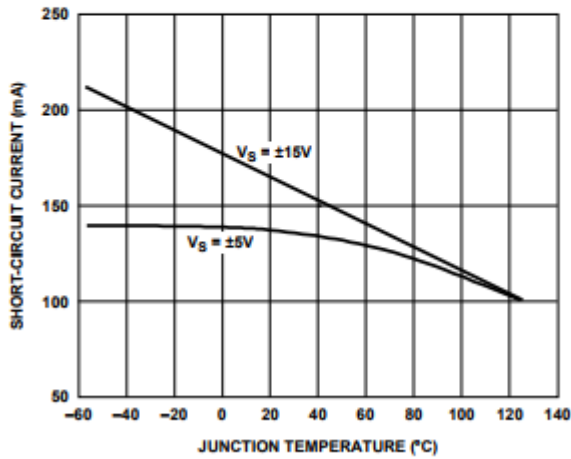


Figure 13. Short-Circuit Current vs. Junction Temperature

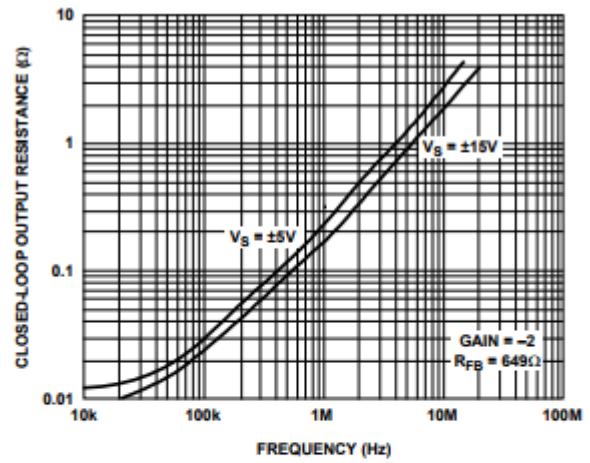


Figure 14. Closed-Loop Output Resistance vs. Frequency

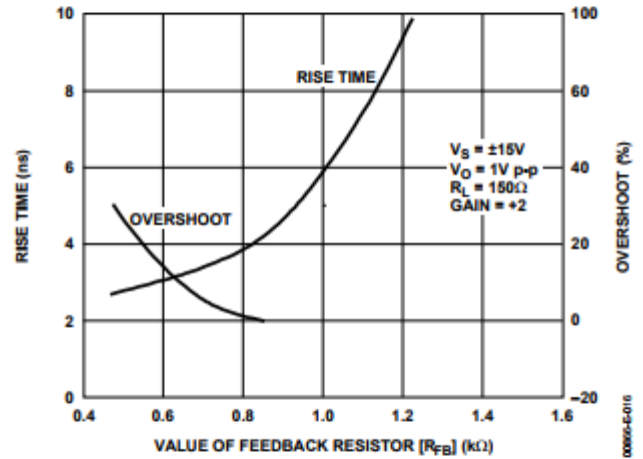


Figure 15. Rise Time and Overshoot vs. Value of Feedback Resistor, R_{FB}

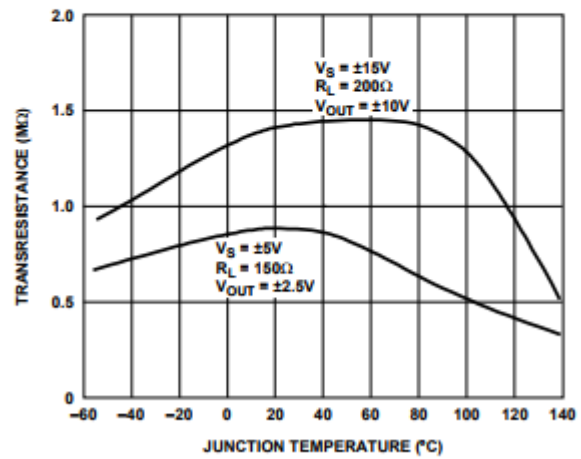


Figure 16. Transresistance vs. Junction Temperature

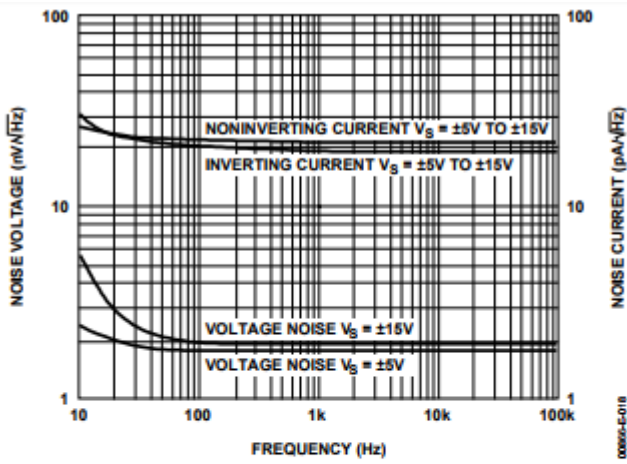


Figure 17. Input Noise vs. Frequency

00066-E-010

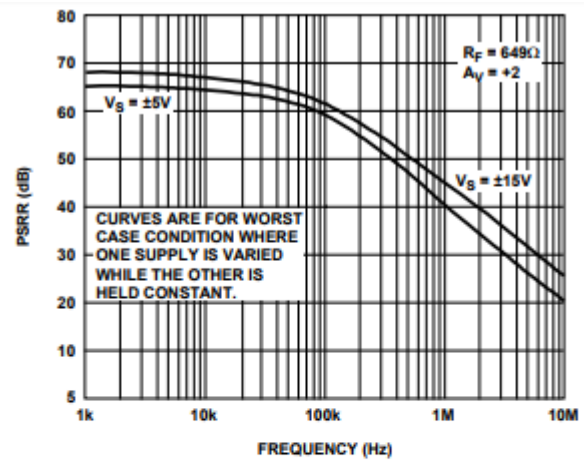


Figure 20. Power Supply Rejection Ratio vs. Frequency

00066-E-021

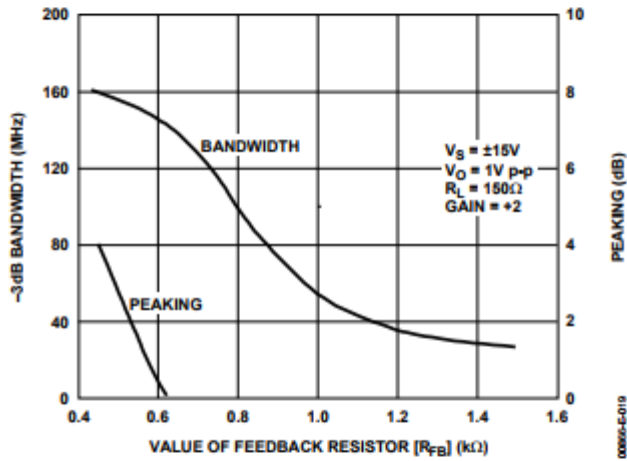


Figure 18. -3 dB Bandwidth and Peaking vs. Value of R_{FB}

00066-E-010

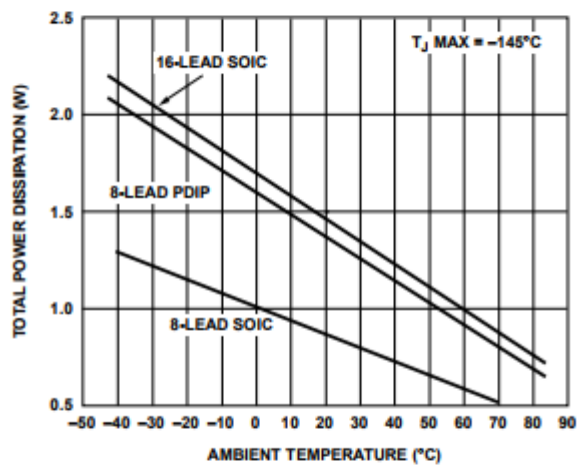


Figure 21. Maximum Power Dissipation vs. Temperature for Plastic Packages

00066-E-022

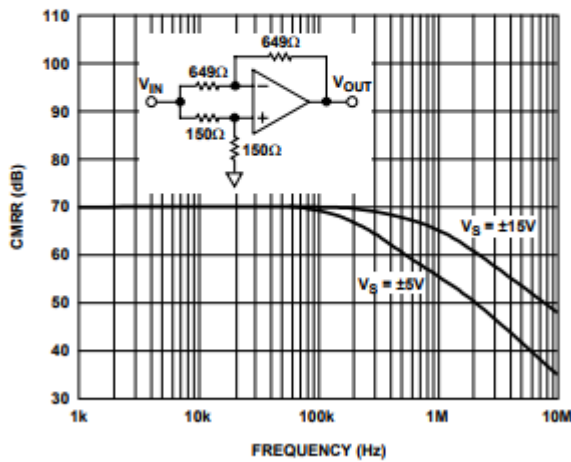


Figure 19. Common-Mode Rejection Ratio vs. Frequency

00066-E-020

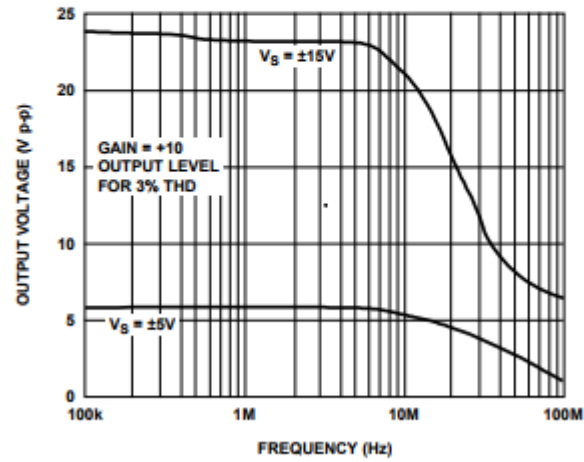


Figure 22. Large Signal Frequency Response

00066-E-023

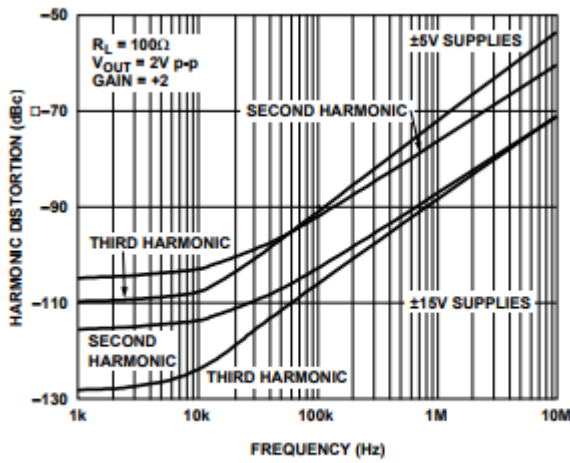


Figure 23. Harmonic Distortion vs. Frequency

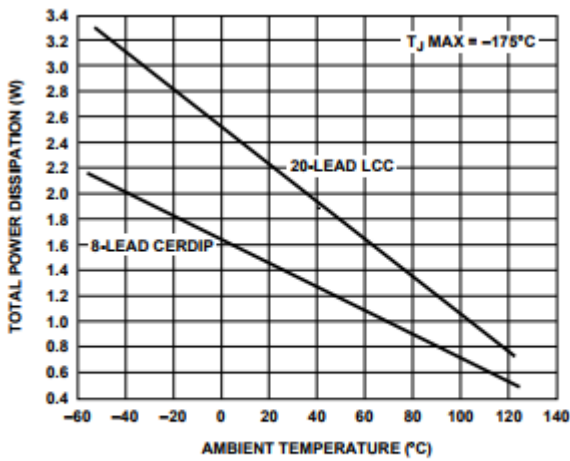


Figure 24. Maximum Power Dissipation vs. Temperature for Hermetic Packages

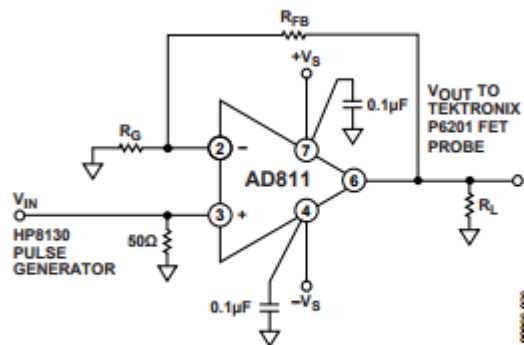


Figure 25. Noninverting Amplifier Connection

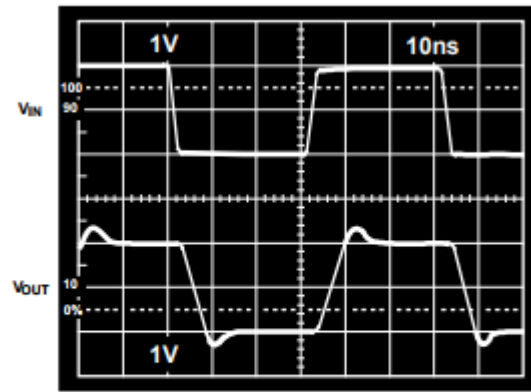


Figure 26. Small Signal Pulse Response, Gain = +1

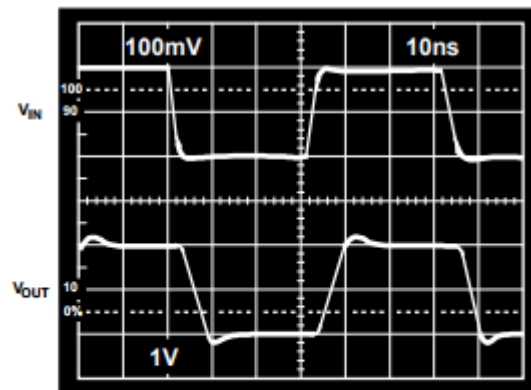


Figure 27. Small Signal Pulse Response, Gain = +10

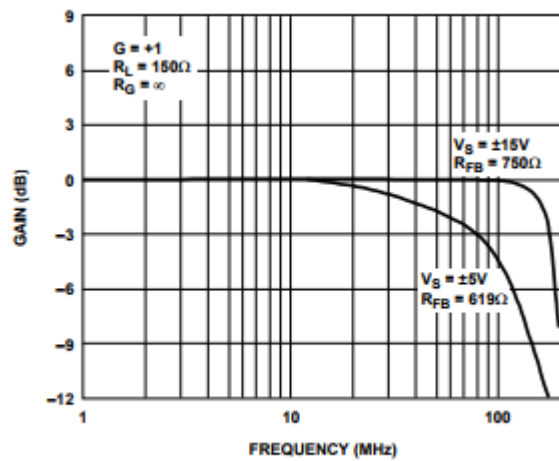


Figure 28. Closed-Loop Gain vs. Frequency, Gain = +1

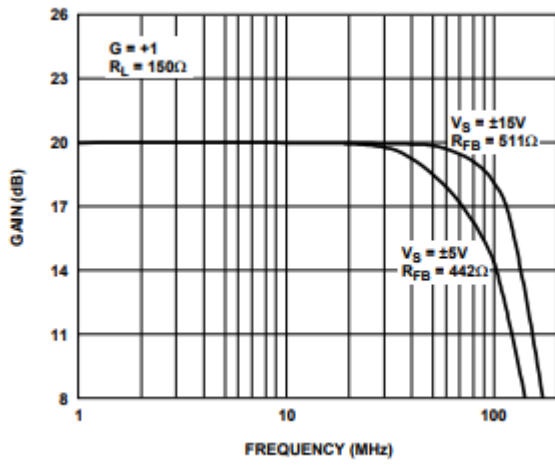


Figure 29. Closed-Loop Gain vs. Frequency, Gain = +10

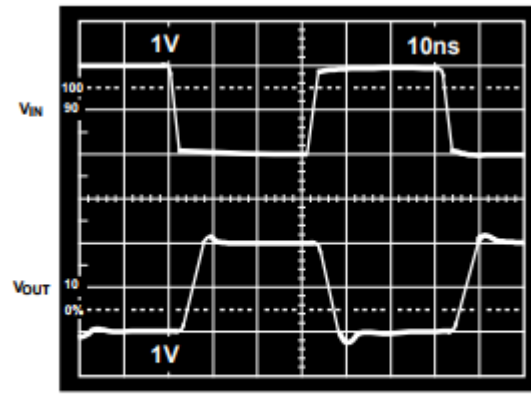


Figure 32. Small Signal Pulse Response, Gain = -1

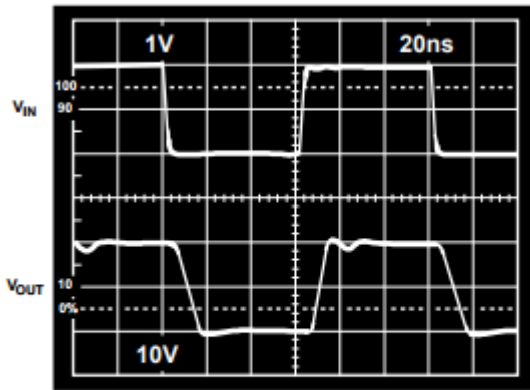


Figure 30. Large Signal Pulse Response, Gain = +10

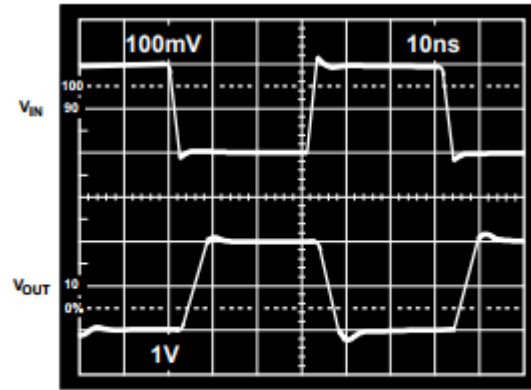


Figure 33. Small Signal Pulse Response, Gain = -10

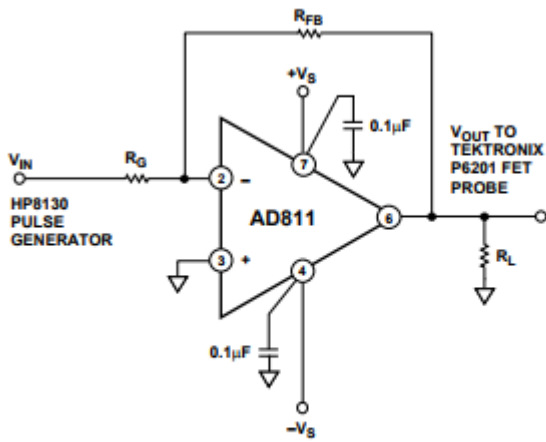


Figure 31. Inverting Amplifier Connection

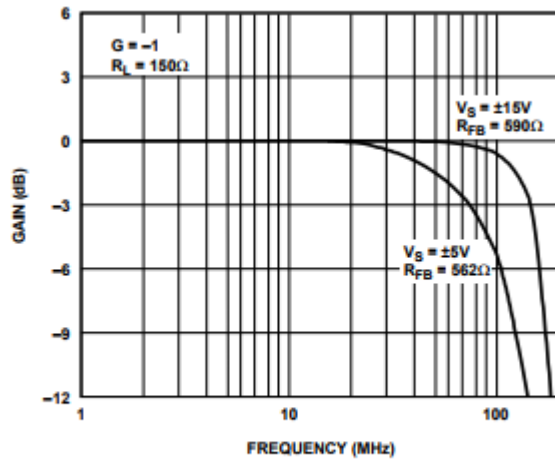


Figure 34. Closed-Loop Gain vs. Frequency, Gain = -1

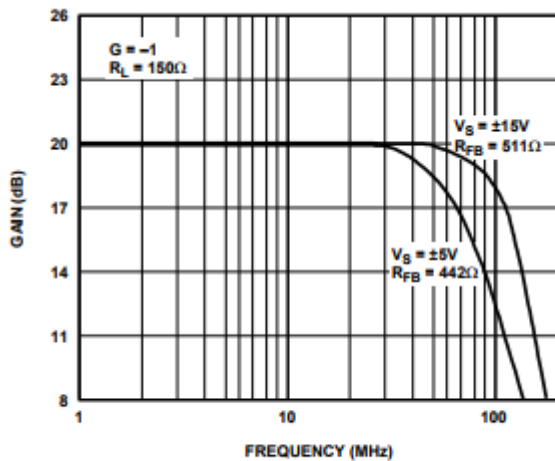


Figure 35. Closed-Loop Gain vs. Frequency, Gain = -10

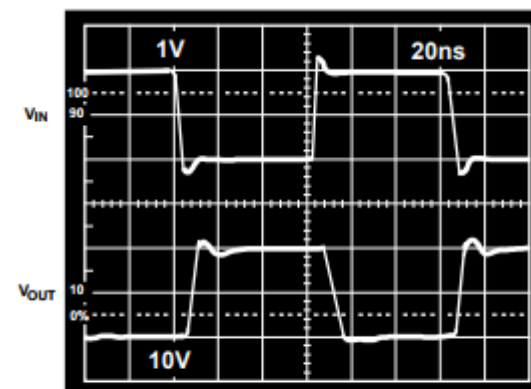


Figure 36. Large Signal Pulse Response, Gain = -10

